



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : **Confirmation No. 1388**
Akihisa HONGO et al. : Docket No. 2001-0924A
Serial No. 09/891,472 : Group Art Unit 1742
Filed June 27, 2001 : Examiner Donald R. Valentine

METHOD AND APPARATUS FOR
FORMING INTERCONNECTS, AND
POLISHING LIQUID AND POLISHING
METHOD

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AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action of July 18, 2003, the period for response to which having been extended by one month to November 18, 2003, kindly amend the above-referenced U.S. patent application as follows:

AMENDMENTS TO THE TITLE

Please change the title of the invention as follows:

~~METHOD AND APPARATUS FOR FORMING INTERCONNECTS, AND POLISHING LIQUID
AND POLISHING METHOD~~